

Adhesive tape solutions for consumer electronics

Enabling the future of consumer electronic devices

About us

tesa

Qualified experience and individual support

As a leading adhesive manufacturer in the electronics industry, we offer a wide range of customized adhesive tapes for smartphones, tablets, and other electronic devices. We work continuously to develop new products to better serve you and your customers in this fast-moving and innovative industry. You and your suppliers are our priority. Our team of experts – from sales offices, R&D centers, and manufacturing facilities – is available globally to support you locally. In particularly, our Customer Solution Center with its technical experts is there to offer you the individual support you need. Our state-ofthe-art facility with extensive equipment is at your disposal to find the adhesive solution for your needs.

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Your complete partner

Solutions that go beyond tape

Every project comes with new and individual challenges. We overcome these challenges by partnering with you to create unique and specialized products that meet and exceed your customers' expectations. Our capability goes beyond tape, as we also offer a comprehensive technical product package.

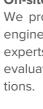


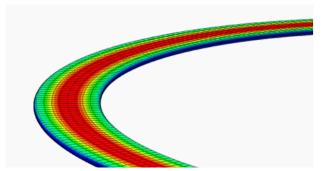
Our labs and technical experts

With our extensive experience in adhesive technology, we have developed a large portfolio of adhesive products for electronics applications.

Our technical experts will support you throughout your entire product development process and help you find the optimal solution for your requirements.







Finite Element Analysis (FEA)

FEA is a critical tool in the design and optimization of products, allowing engineers to predict the behavior of materials and components under various conditions. At tesa, we have developed significant expertise in material modeling and FEA. This enables us to offer our customers detailed virtual insights into the performance of our adhesive solutions.

Our FEA capabilities extend across a wide range of applications, where we support our customers in stress analysis, thermal simulations, and dynamic modeling. Using accurate predictions will help optimize product designs, reduce costs, and enhance reliability. We leverage state-of-the-art and advanced modeling techniques to deliver precise simulations that reflect real-world conditions.

By integrating FEA into your development process, you can ensure that our adhesive tapes meet the highest standards of performance and durability in your applications.

If you are interested in material modeling and FEA, please contact our sales representative.



On-site support

We provide individual project support backed up by application engineers and research and development resources. Our technical experts in our Customer Solution Center offer on-site support and evaluation of your individual application under laboratory condi-

Contact us

Our local experts and engineers are just a phone call away to support you with:

- Process-simulation studies
- Assistance at your manufacturing site
- State-of-the-art testing equipment
- Tests under a wide range of environmental conditions
- Customized tests with customer substrates

Contact us and benefit from a strong partnership.

Tapes for your success

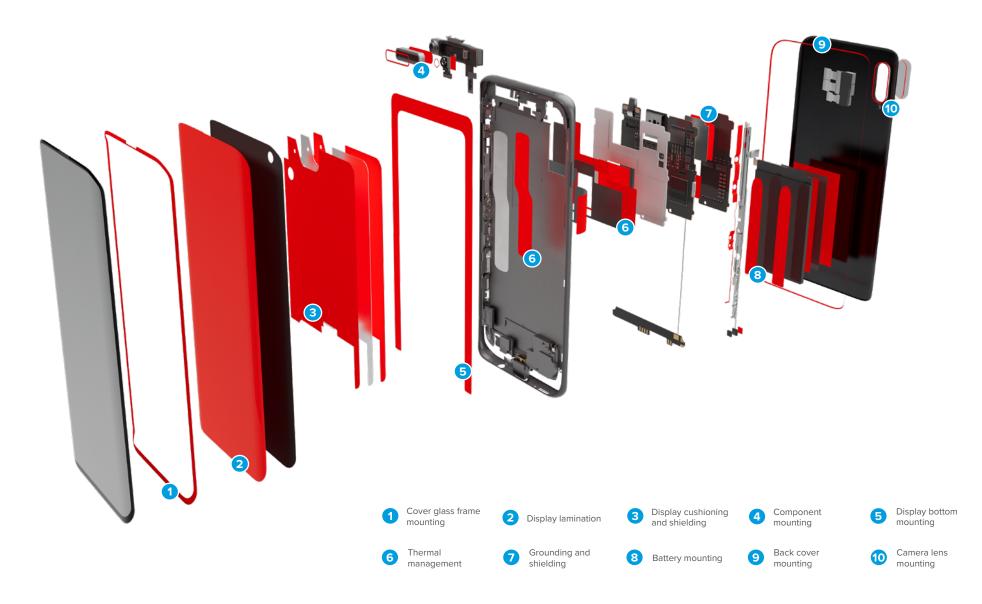
Comprehensive tape solutions for electronic devices

Our extensive expertise in tape application within the electronics sector empowers us to provide exceptional support and guidance in selecting the finest tape solutions for your needs.

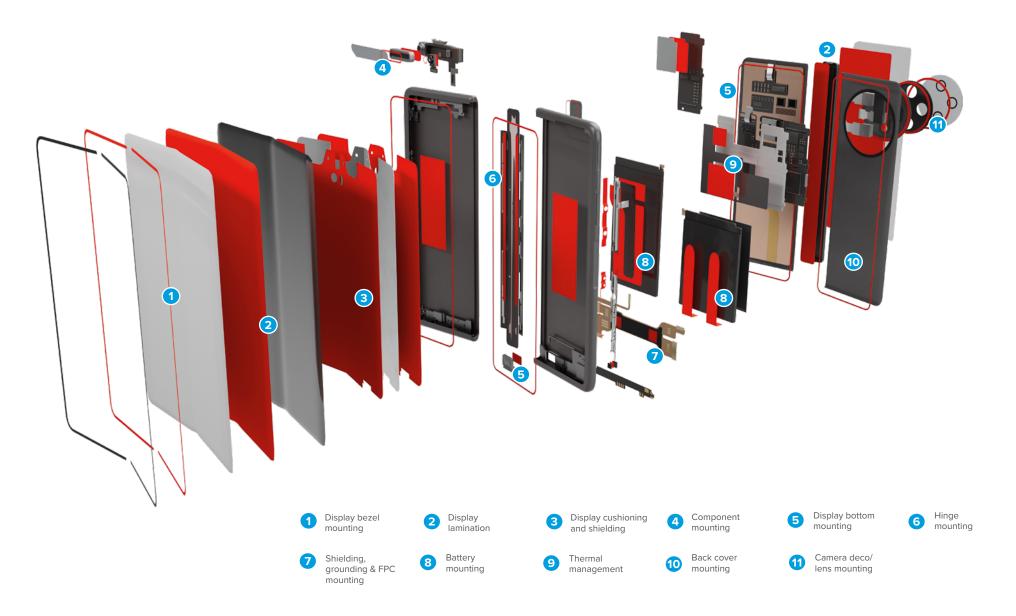
We are committed to enhancing your product development from start to finish. By prioritizing your needs and those of your suppliers, we ensure personalized and dedicated service. Our mastery in tape applications equips us to offer you the best in adhesive tape solutions, staying abreast of the latest innovations and market technologies in electronics. This enables us to supply a diverse array of specially designed adhesive tapes for smartphones, tablets, and other electronic devices.



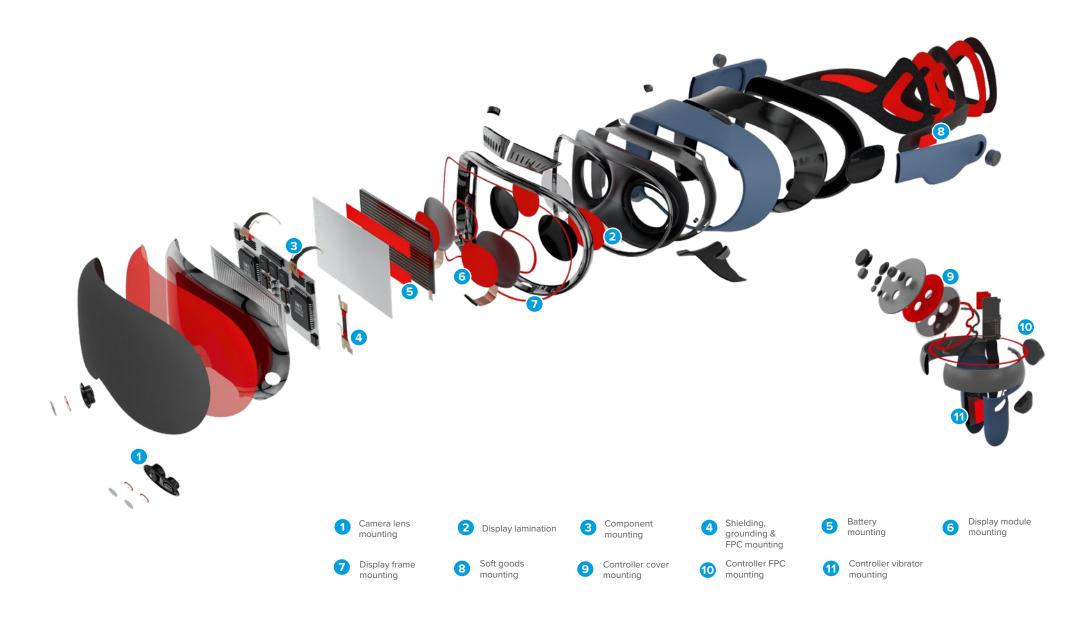
Tapes for your success – Smartphones



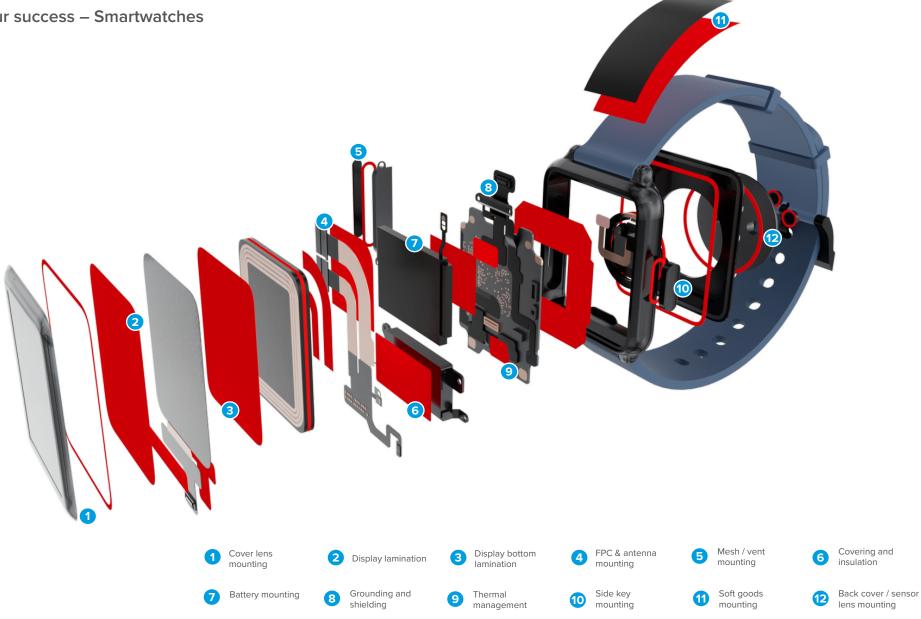
Tapes for your success – Foldable smartphones



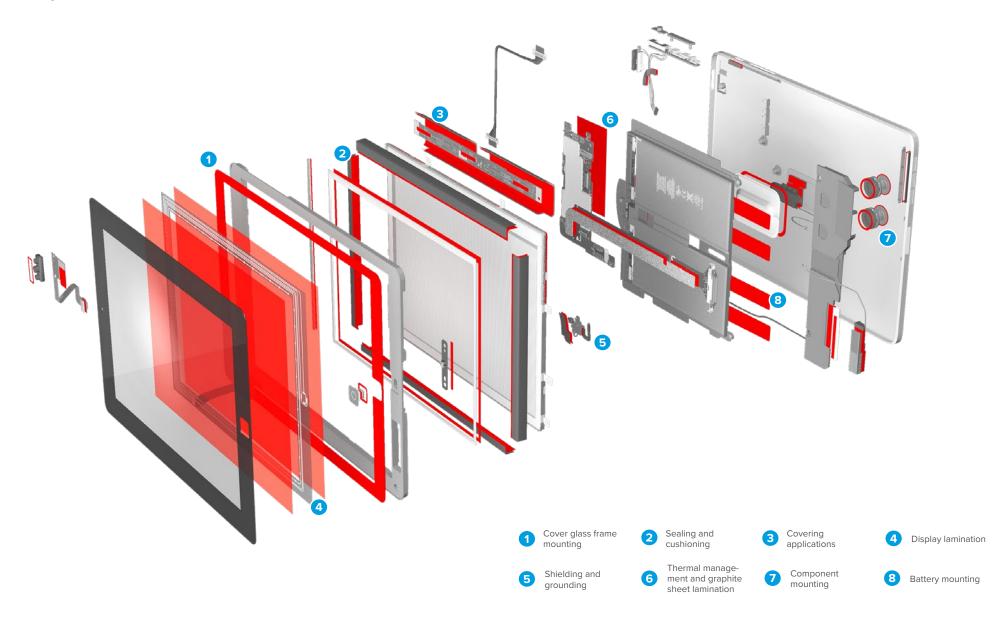
Tapes for your success – AR/VR device



Tapes for your success – Smartwatches



Tapes for your success – Tablets



We are strongly committed to sustainability

Sustainability and performance go hand in hand

At tesa, we believe that quality, innovation, performance, and sustainability all go together in this journey. Therefore, our assortment does not compromise the reliability and state-of-the-art bonding capabilities our customers rely on. By aligning our products with the needs of our customers, we contribute towards helping them achieve their own sustainability goals.

More than six hundred scientists, engineers, and product developers at tesa are exploring ways to improve the sustainability of our products. We are expanding our use of recycled and biobased materials across all our solutions, for example our assortment of foam, film and electrically conductive tapes for consumer electronic applications.

Given the strong push by the EU on repairability and waste reduction in consumer electronics, it has become increasingly important to be able to dissemble and rework devices. tesa's "Debonding on Demand" has the potential to cut waste, boost recycling, enable product repairs and promote a circular economy across industries.

Want to know more about sustainability at tesa? Klick the QR code!





Tackling the global climate crisis and accelerating positive change are central elements of our commitment. Our mission to reduce global emissions includes upstream and downstream processes as well as our own production.

We record, consolidate, and analyze our energy consumption in accordance with the guidelines of the Greenhouse Gas Protocol.

We record, consolidate, and analyze our energy consumption in accordance with the guidelines of the Greenhouse Gas Protocol.

Green energy is a key pillar of our commitment. Since 2020, we have sourced 100 percent of our purchased electricity from renewable energy sources.

Responsible sourcing	

CDP

A LIST

2023

CLIMATE

Responsible procurement is the first step in the life cycle of a sustainable product.

We want to ensure that fair working conditions and human rights as well as environmental protection are in place in the supply chain. To do this, we strictly enforce supplier traceability and high transparency of our value chain: certifying our raw materials, evaluating suppliers and participating in associations.

tesa is a recognized CDP A for climate and EcoVadis Gold supplier, showcasing our efforts in the area of climate protection, responsible production and supply chain transparency.



GOLD

ecovadis

202

Use of recycled and bio-based materials



Circularity and reduction of waste

tesa has set itself the goal of significantly increasing product sustainability and is working on this every day.

Since 2023, we have launched 10 more sustainable products for the electronics sector, and we are currently working on many more. In doing so, we are focusing on the reduction of non-recycled fossil plastics and will increasingly use recycled and bio-based materials.

We have a comprehensive carbon footprint database, and we are continuously improving our data quality. Additionally, we conduct external life cycle assessments to ensure a science-based approach. tesa will contribute to the circular economy and use resources as carefully as possible. First and foremost, this involves avoiding waste. Whenever this is not possible, we reduce it. If waste is unavoidable, we seek to reuse or recycle it by various means. By 2025, we want to eliminate all landfill disposal of production-related waste.

Since 2023, we have made significant progress in reducing plastic film liner usage and initiated pilot projects with customers to collect and reuse plastic end-wall covers for log rolls. Thanks to this, we are recovering approximately 165,000 end-walls from customers.





Enable sustainability at customer



Our versatile building blocks empower customers to improve reworkability in production, enhance repairability throughout the lifespan of devices, and achieve optimal recyclability after their life cycle.

tesa is at the forefront of revolutionizing the industry with our groundbreaking "Debonding on Demand" adhesive tapes: tesa® Bond & Detach has set a solid foundation for more sustainable and efficient manufacturing processes.

With an impressive portfolio of over 50 patents filed, we ensure reliable bonding performance, offer smart debonding options, and enable maximum design freedom for our customers.

Structural bonding solutions 25

The best reliability for the toughest demands

tesa® structural bonding solutions provide high bonding performance to a wide variety of substrates. They withstand the harshest conditions by combining outstanding chemical and aging resistance. The processing of these adhesive systems is simplified due to excellent die cuttability, immediate handling stability after activation, and low oozing.

Ja

Heat-activated films

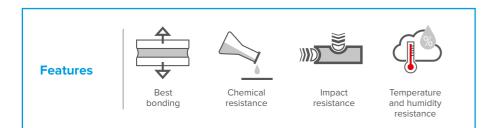
tesa HAF® is a thermosetting adhesive system. An irreversible cross-linking reaction is initiated by heat and pressure starting at temperatures above 120°C, resulting in extremely strong bonds.

Low-temperature activated films

Our low-temperature reactive films tesa® LTR and tesa® LTC have been designed for activation at moderate temperatures. The cross-linking starts at a bond-line temperature above 75°C. tesa® LTT is a low temperature thermoplastic film designed for soft goods assembly requiring low processing temperatures.

Light-curing tapes

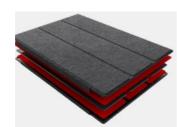
tesa® UV epoxy and tesa® L-tape are our latest developments that will cure at room temperature when exposed to light. They achieve significantly higher bonding strengths compared to PSAs. They come with high initial tack and immediate holding strength after bonding.

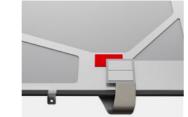


Typical applications









Component mounting

Cover lens mounting

Soft goods bonding

FPC mounting

Assortment overview

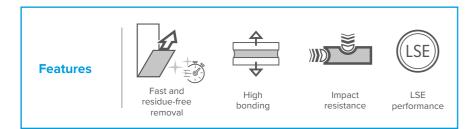
		Heat-activated films	Low-t	Low-temperature activated films		Light-curing tapes		
		tesa HAF®	tesa® LTR	tesa® LTC	tesa® LTT	tesa® UV epoxy	tesa® L-tape	
Desig	n							
Color		Black, amber	Black, white, translucent	Black	Translucent	White	Translucent	
Adhes	sive	Nitrile rubber/phenolic resin	Cross-linkable polyurethane	Cross-linkable polyurethane	Thermoplastic polyurethane	Light curable	Light curable	
ctiva empe	tion erature [°C]	>120	>75	>75	>80	Room temperature	Room temperatur	
ipecia eatur		Temperature resistance, chemical resistance	Impact resistance, wettability on fabrics	Impact resistance, chemical resistance	High peel adhesion to fabrics	Activation at room temperature, reworkability	Activation at roon temperature, impa resistance	
	10 µm	● 58469						
	20 µm	• 58477						
	25 µm			• 58720				
	30 µm	• 58471 • 8471	O 8711		O 8741			
	50 µm	● 58470	• 58480	● 58722	O 8742		Q 8692	
	60 µm	● 8472						
	80 µm	• 58473						
	100 µm	584748474	● 58484 ○ 8714	● 58724		O 8684	O 8694	
	125 µm	• 58475 • 8475						
	150 μm	584768476	● 58486					
	200 µm	• 58478 • 8478	● 58488				O 8698	
	250 μm			● 58729				
	300 µm		• 58489					
_	Reference product	● 58474	● 58484	• 58724	Q 8742**	0 8684	Q 8694	
	Reference substrate	SUS/SUS	PC/PC	Al/Al	PC/PC	PC/PC	AI/PC	
	Push-out [MPa]	>9.0	>5.5	>4.0	>2.5	>2.5	>3.0	
	DuPont [J; xy/z]	>0.5	>4.0	>1.0	n.a.	>0.5	>1.0	
	Reliability*	••••	•••	••••	••	•••	•••	
	Chemical resistance*	••••	••	•••	•	••	••	



Stretch-release tapes for residue-free removability

Our Bond & Detach® solutions have revolutionized the removability of adhesives. This tape enables the permanent mounting of components with the option of removing them without residues. Bond & Detach® uses a unique adhesive technology for demanding bonding applications, that can be removed without leaving any residue by stretching it.

The patented technology was developed by tesa and offers the possibility of simple and secure debonding during the entire product life cycle - from production to end of life. It can also be used for temporary fixation during production processes or transportation. In addition, the whole assortment provides good impact resistance and bonding strength, even on LSE substrates.



Typical applications



Battery mounting in mobile

devices



Removable mounting of devices or accessories



Temporary fixation of components



Mounting of valuable components

Assortment overview

	tesa® 704xx/703 /706xx	tesa® 672xx	tesa® 770xx	tesa® 648xx	tesa® 705xx	tesa® 769xx
Design						
Color	White, transparent, black Specialty	White	Translucent white	White	White	Black
Adhesive		Specialty	Specialty	Specialty	Specialty	Specialty
Backing	-	Stretchable PU	Stretchable specialty	Stretchable specialty	-	-
Special features	Bonding strength, easy activation	High impact resistance	Impact resistance, tear resistance	Impact resistance, tear resistance	Anti-repulsion, temp. resistance	Pin tensile streng
80 µm		O 67208**				
100 µm	○ 70410● 70610	0 67210**	o 77010	O 64810**		
150 μm	o 70415 ● 70615	0 67215	o 77015	0 64815 0 64816		
175 µm			0 77017			
200 µm	○ 70420● 70620			0 64820		
250 μm	0 70425 ● 70625	0 67225		O 64825	0 70525	● 76925*
300 μm	o 70430 ● 70630			O 64830		• 76930
350 μm	• 70635					
400 μm	o 70440 ● 70640					
500 µm	o 70350 ● 70650				0 70550	• 76950
650 μm	0 70465 ● 70665					
800 µm	o 70480 ● 70680					
1,000 μm	o 70499 ● 70699					
1,300 µm	● 70697					
Reference product	o 70415 ● 70615	O 67215	o 77015	O 64815	o 70525*	● 76925*
Peel SU adhesion [N/cm;initial/ ultimate] F DuPont [J; xy/z]	IS 13.0/13.0	9.0/9.0	10.0/10.0	11.0/11.0	13.0/13.0	13.0/13.0
[N/cm;initial/ ultimate] P	PE 7.0/7.0	6.0/6.0	7.0/8.0	8.0/8.0	9.0/9.0	10.0/10.0
DuPont [J; xy/z]	0.7/0.3	1.0/0.7	1.0/0.7	1.1/0.8	1.0/0.7	0.8/0.4
[cycles]	Upon request	>500	>500	500	Upon request	Upon request
Removing forc [N/cm]	e 4.0	5.0	4.0	4.0	6.0	5.0

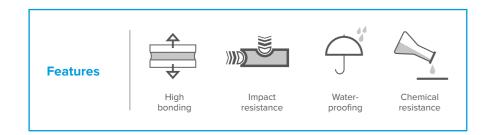
		tesa [®] 704xx/703 /706xx	tesa [®] 672xx	tesa® 770xx	tesa® 648xx	tesa® 705xx	tesa® 769xx
Des	ign						
Cole	or	White, transparent, black	White	Translucent white	White	White	Black
٩dh	esive	Specialty	Specialty	Specialty	Specialty	Specialty	Specialty
Bac	king	-	Stretchable PU	Stretchable specialty	Stretchable specialty	-	_
-	cial ures	Bonding strength, easy activation	High impact resistance	Impact resistance, tear resistance	Impact resistance, tear resistance	Anti-repulsion, temp. resistance	Pin tensile strengt
ş	30 μm		O 67208**				
1	00 µm	o 70410 ● 70610	0 67210**	o 77010	O 64810**		
1	50 µm	o 70415 ● 70615	0 67215	O 77015	O 64815 O 64816		
1	75 µm			0 77017			
	200 μm	o 70420 ● 70620			0 64820		
1	250 μm	0 70425 ● 70625	0 67225		O 64825	0 70525	● 76925*
1.1	300 μm	o 70430 ● 70630			O 64830		● 76930
1.1	3 50 μm	• 70635					
4	l00 μm	○ 70440● 70640					
Ę	500 μm	○ 70350● 70650				0 70550	● 76950
(650 μm	○ 70465● 70665					
8	300 μm	○ 70480● 70680					
1	,000 μm	o 70499 ● 70699					
1	,300 μm	• 70697					
F	Reference product	○ 70415● 70615	O 67215	o 77015	O 64815	o 70525*	● 76925*
	Peel SUS	13.0/13.0	9.0/9.0	10.0/10.0	11.0/11.0	13.0/13.0	13.0/13.0
[N/cm;initial/ Iltimate] PE	7.0/7.0	6.0/6.0	7.0/8.0	8.0/8.0	9.0/9.0	10.0/10.0
[DuPont J; xy/z]	0.7/0.3	1.0/0.7	1.0/0.7	1.1/0.8	1.0/0.7	0.8/0.4
	[umbler cycles]	Upon request	>500	>500	500	Upon request	Upon request
	Removing force N/cm]	4.0	5.0	4.0	4.0	6.0	5.0

** Upon request

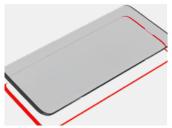
Acrylic foam tapes

For applications with extreme requirements

Our acrylic foam tape assortment is especially designed for demanding applications in the electronics industry and is distinguished by its very special bonding capabilities. The high bonding performance is possible due to the tape's viscoelasticity: elastic and viscous characteristics provide inner strength and relax mechanical stresses. The use of highly innovative technologies and special acrylic adhesive systems together with the viscoelastic nature of acrylic foams create multiple benefits like impact resistance, high bonding strength, and waterproofing for electronic devices for the entire life cycle of the product.

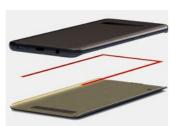


Typical applications



18 Mounting solutions – Impact-resistant foam tapes







Cover lens mounting

Assortment overview

		tesa® 751xx	tesa® 754xx/756xx	tesa® 6108x	tesa® 760xx	tesa® 7588x	tesa® 757xx
Des	sign						there entropy and
Col	or	Black	Black	Black	Black	Black	Black, white
Adl	nesive	Modified acrylic	Modified acrylic	Tackified acrylic	Tackified acrylic (66% bio-based carbon content)	Acrylic	Modified acrylic
Bac	:king	-	-	AC foam	-	-	PET
	ecial tures	Outstanding impact resistance	Outstanding bonding	Easy activation, inner force resistance	Balanced performance, high bio content	Chemical resistance	Balanced performance
	50 µm		• 75405			● 75881	
	100 µm		● 75410		• 76010	• 75882	• 75710
	150 μm	• 75115	• 75415		• 76015	• 75883	• 75715
	200 µm	• 75120	• 75620		• 76020	• 75884	• 75720 0 75743
SS	250 μm	• 75125	● 75625				• 75725 0 75745
Thickness	300 µm	• 75130	• 75630	● 61086			• 75730
-	350 µm		• 75635	● 61087			
	400 μm		● 75640	● 61088			
	450 μm		● 75645				
	500 μm		● 75650				
	Reference product	• 75120	● 75620	● 61086	●76020	• 75884	● 75720
Product performance	Peel adhesion [N/cm; SUS initial/ ultimate]	13.0/15.0	15.5/17.0	15.5/17.5	11.0/12.0	8.0/10.0	14.0/15.0
roduc	Push-out [N]	300	225	215	120	185	205
-	DuPont [J; xy/z]	1.4/1.2	1.3/1.0	1.6/1.3	1.0/0.8	1.4/1.2	0.9/0.8
	Remov- ability*	••	•	••	••	•	•••

Your partner for codevelopment

We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands. **Simply write to us or contact your local** representative: electronics@tesa.com

Cover glass frame mounting

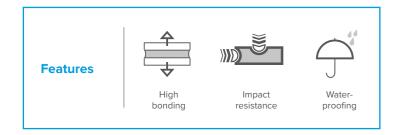
Back cover mounting

Display bottom mounting



For challenging applications

PE foam tapes have long proven their value to the electronics industry. Certain properties such as impact resistance, bonding strength, and waterproofing are offered by all series in our PE foam range. In this section we present a selection of our PE foam solutions focusing on different series' specific performance features. If you require more information than what we have provided here, please contact your local representative.



Typical applications



Cover glass frame mounting



Back cover mounting



Camera lens mounting



Display bottom mounting

Assortment overview

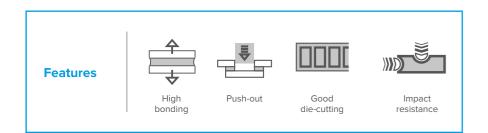
		tesa® 6208x	tesa® 668xx	tesa® 6368x	tesa® 626xx	tesa® 6216x	tesa® 66425
Design				2			
		A STATE OF THE OWNER	and the second second	No. of Concession, Name		J. 2	
Col	lor	Black	Black, white	Black	Black	Black	Black
Adl	hesive	Acrylic	Acrylic	Acrylic	Acrylic	Special	Acrylic
Bad	cking	PE foam	PE foam	PE foam	PE Foam (partly with PET reinforcement)	PE foam	PE Foam (with PE reinforcement)
	ecial tures	Gap closing, shear resistance	Anti-repulsion, impact resistance	Bio-based	Bonding, conformability	Fast heat removal	Cuttable for rewo
	150 μm	● 62082	● 66822				
SS	200 µm	● 62084	● 66824		• 62624		
	250 μm	● 62085	● 66825	€ 63685	● 62625 ● 62645		
	280 μm						• 66425
Ξ	300 µm	● 62086	● 66826	€ 63686	● 62626 ● 62646	• 62166	
	350 μm	● 62087					
	400 µm	● 62088	● 66828				
	Reference product	● 62086	● 66826	● 63686	● 62626	● 62166	● 66425
	Peel adhesion SUS	11.5/13.5	12.5/14.5	14.0/14.0	13.0/16.0	Provided per request	Provided per requ
	[N/cm; initial/ PC ultimate]	11/14.5	12.5/16.0	12.0/12.0	15.0/16.0	Provided per request	Provided per requ
	Push-out [N]	220	252	175	180	180	210
	DuPont [J; xy/z]	0.52/0.5	0.88/0.77	0.38/0.43	0.48/0.42	0.55/0.65	0.49/0.47
-	Compression force at 25% [kPa]	365	515	375	200	400	320
	Rework- ability*	•••	•••	••	•	••••	••••
	Anti-repulsion*	••••	•••	•	•	•	••

20 Mounting solutions – Impact-resistant foam tapes



High performance profile

Our high performance profile tapes are the spearhead of our film tapes assortment. All series in this category are characterized by superior bonding performance, which is expressed in peel adhesion, push-out and shear resistance, and high impact resistance. This assortment is therefore used for demanding applications like lens and battery mounting. The PET backings used are very well suited to being die-cut.



Typical applications



Cover glass frame mounting

Battery mounting



Component mounting

Assortment overview

		tesa® 613xx	tesa® 618xx	tesa® 6887x	tesa® 6896x
Des	sign			A	
Col	or	Transparent, black	Black	Transparent	Transparent
Adl	hesive	Tackified acrylic	Modified acrylic	Bio-based acrylic (75% bio-based carbon content)	Specialty
Bac	king	PET	PET	PCR PET (100% PCR content)	PET
	ecial tures	Push-out resistance, bonding strength	Push-out resistance, impact resistance, LSE performance		Quick bonding, LSE performance
	30 µm			0 68873	O 68960
	50 µm	○ 61305● 61350		✓ 0 68875	0 68962
	100 µm	○ 61360● 61365	● 61865	<i>€</i> 0 68877	O 68964
n	125 µm	○ 61370● 61375			
Inickness	150 μm	○ 61380● 61385	● 61885	<i>€</i> 0 68878	
Ξ	200 µm	○ 61390● 61395	● 61895		
	230 µm	● 61345	● 61845		
	250 μm	• 61325	● 61825		
	300 µm	● 61315	● 61815		
a	Reference product	● 61365 ○ 61360	● 61865	O 68877	O 68964
Product pertormance	Peel adhesion SUS [N/cm; initial/ ultimate]	13.7/16.5	11.0/12.0	12.6/12.8	17.0/17.5
Ŏ	Push-out [N]	230	240	Upon request	255
	DuPont [J; xy/z]	0.5/0.2	0.7/0.3	Upon request	0.7/0.6

O Transparent • Black

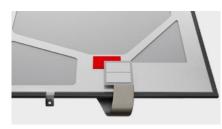


Specialized performance profile

With this assortment, we created double-sided mounting tapes with unique adhesives focusing on the special requirements of certain applications in the electronics industry. Each series within this assortment focuses on a specific property needed in the market. In this section, you will find a selection of specialized film tapes. Our capabilities go beyond what is available here. Please contact our local representatives to discuss this further.



Typical applications



FPC mounting

packaging applications.

Rubber-foot mounting



ting

Our specialized film tape solutions are suitable for applications with a high demand for a certain property like anti-repulsion, differential bonding performance, chemical resistance, reworkability, or light blocking. These tapes are suitable for a wide range of applications, from mounting (e.g. FPC, antenna, keypad, sensor) to processing and



Sensor mounting

Solutions with sustainable contribution

We are continuously increasing our range of products with sustainable aspects to help our customers achieve their own sustainability goals. We are willing to offer products that have the lowest possible impact on the environment throughout their life cycle. The use of recycled and bio-based raw materials plays a particularly important role here. In our product development, we focus on the design and integration of various more sustainable building blocks in order to provide our customers with the greatest possible flexibility in the selection of products. Reach out to us, learn more about this exciting development, and become part of it!

Assortment overview

		tesa® 6693x	tesa® 615xx	tesa® 6881x	tesa® 885x
Des	sign				Construction of the
Col	lor	Transparent	Transparent	Black	Translucent
١d	hesive	Tackified acrylic	Silicone/acrylic	Tackified acrylic	Tackified acrylic
a	cking	PET	PET	PET	Non-woven
	ecial tures	Anti-repulsion, easy activation	Si/Ac differential, LSE	LSE, high tack, impact resistance	Temperature resistance
	30 µm	O 66930	O 61526		O 8851
	50 µm	O 66932	O 61532	● 68812	0 8853 0 8857
	60 µm			● 68811	
2	80 µm			• 68813	
	100 µm	O 66934	0 61528	• 68814	0 8854
	140 µm		O 61529		
	150 μm				
	200 µm		0 61520	● 68817	
	250 μm				
	Reference product	O 66934	O 61528	● 68814	o 8854
Product performance	Peel adhesion [N/cm; SUS initial/ ultimate]	10.7/11.6	Si: 4.0/4.4 Ac: 11.3/12.6	13.5/14.0	8.3/9.5
Ē	Push-out [N]	143	Upon request	130	Upon request
	DuPont [J; xy/z]	0.7/0.2	Upon request	0.9/0.5	Upon request



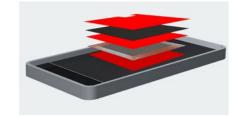
Balanced performance profile

tesa[®] balanced-performance film tapes are a proven solution for mounting and lamination applications in the electronics industry. The balanced adhesive provides very good tack and bonding performance for many general applications. The PET backing enables easy handling of the tape during converting and manufacturing processes. With thicknesses from 5 μm to 250 μm, this assortment offers you a broad range and excellent flexibility.



Typical applications





Battery mounting

Graphite sheet lamination

This assortment is widely used in the electronics industry for versatile mounting and lamination applications as well as for cushioning and gasket material bonding.

Assortment overview

	tesa® 49xx	tesa [⊗] 519xx
Design		
Color	Transparent	Black
Adhesive	Tackified acrylic	Tackified acrylic
Backing	PET	PET
30 µm	O 4983	● 51983
50 µm	0 4972	• 51972
80 µm	O 4980	• 51980
100 µm	O 4982	• 51982
125 µm 140 µm	O 4928	• 51928
140 µm	0 4942	
150 μm		
160 μm	o 4967	• 51967
200 µm	O 4965	• 51965
250 μm	O 4926	● 51926
Reference product	O 4982	• 51982
Peel adhesion [N/cm; initial/ ultimate]	11.0/11.7	11.0/11.7
Push-out [N]	230	230
DuPont [J; xy/z] SUS	0.5/0.2	0.5/0.2

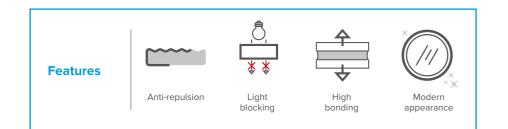
Can't find the right solution?

We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands. Simply write to us or contact your local representative: electronics@tesa.com



More functionality for electronic devices

Electronic components are evolving one generation after the other, just like our solutions for covering tape. Our portfolio consists of polyester and polyimide tapes.



Assortment overview

	tesa® 79 xx	tesa® 71xx	tesa® 673xx	tesa® 663xx
Design				
Color	Matte black	Black	Matte black	Amber
Adhesive	Black tackified acrylic	Black tackified acrylic	Tackified acrylic	Tackified acrylic
Backing	Polyester	Polyester	PI	PI
Special features	Modern design, anti-repulsion	Bonding strength, dielectric insulation	Heat resistance, dielectric insulation	Heat resistance, dielectric insulation
5 µm	• 7905			
8 µm				
10 µm	• 7910		• 67310	
20 µm	● 7920		• 67320	● 66320
30 μm	• 7930		• 67330	• 66330
30 μm 50 μm	• 7950	• 7250	• 67350	
60 µm		• 7160		
80 µm		● 7180		
100 µm		• 7100		
Reference product	• 7950	• 7250	● 67350	● 66330
Peel adhesion [N/cm; SUS initial ultimate] Light blocking [optical density]	4.0	4.2	3.5	3.0
Light blocking [optical density]	5.7	>6	2.6	n.a.
Insulation [kV, dielectric breakdown voltage]	5.5	5.0	3.6	3.6
Anti-repulsion*	••••	Upon request	••••	••••

Typical applications



Light blocking in LCD backlight unit

Covering



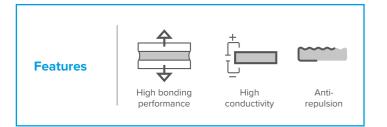
Insulation on PCB and FPC



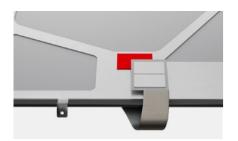
For applications requiring grounding

By offering a broad assortment of filled acrylic adhesive systems, with a balance between electrical conductivity and adhesive properties, we are able to provide the best solution for your requirements. Simply decide what is the most important for your application: bonding performance, conductivity, or a balance of both.

Our double-sided tapes are available with two different backings. The woven backing offers a higher tear resistance, very good dimensional stability, and better reworkability, while the nonwoven backing provides faster wetting, excellent conformability, and very good die cuttability.



Typical applications



FPC grounding



Component grounding

Assortment overview

		tesa® 6025x/6026x	tesa® 6036x	tesa® 6037x	tesa® 6038x	tesa® EC HAF 5845x	tesa® 6066x	tesa® 60250
							Y	
Des	sign		-			-C	+LL	
Col	or	Gray	Gray	Black	Gray	Black	Gray	Gray
Adł	nesive	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive structural adhesive	Conductive bio-based acrylic	Conductive acry
Bac	cking	Woven, non- woven	Woven	Woven, non- woven	Woven, non- woven	-	PCR PET conductive fabric	Woven
	ecial tures	Balanced properties	High bonding strength, high conductivity	Outstanding conductivity	Outstanding bonding, repulsion resistance	Heat-activated structural bonding film, temperature and humidity resistance	Balanced properties	High appearand quality
	17 µm	● 60267						
	25 μm	• 60261						
	30 µm			• 60371	• 60380	• 58451		● 60250
	35 µm	● 60260						
	50 µm	• 60262	• 60362	• 60372	6038160386	• 58452	e 60665	
000	55 µm	● 60251 ● 60252						
	70 µm	● 60253						
	100 µm	● 60254	© 60364	• 60374	• 60384 • 60388		e 60667	
	150 µm	● 60255						
	200 µm	● 60256		X				
	250 μm	● 60257						
	Reference product	© 60252 © 60262	• 60362	• 60372	● 60381 ● 60386	● 58452	● 60667	● 60250
	Peel adhesion [N/cm; SUS initial/ ultimate]	5.4/8.3	7.0/8.0	4.3/5.6	8.0/10.0	n.a.	10.4	>5
n hei i	Dynamic shear [N]	n.a.	n.a.	n.a.	n.a.	>7	n.a.	n.a.
-	Contact resistance [Ω/inch ²]	0.05	0.01	0.01	0.06	0.05	0.05	0.05
	Surface resistance [Ω/sq]	0.2	0.1	0.1	0.3	0.5	0.2	0.2
	Shielding effectiveness [-dB]	>50	>60	>50	>50	~40		

• Black • Gray

Single-sided electrically conductive tapes

For shielding and covering applications

Covering and shielding applications are broad and have different requirements for conductivity, adhesion, and design. Our single-sided ECT assortment meets the latest requirements for shielding and appearance.

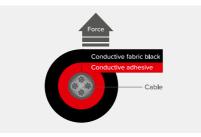


Typical applications





Component shielding



Wire wrapping

Assortment overview

		tesa® 6023x	tesa® 6033x	tesa® 6053x	tesa® 6031x	tesa® 6034x	
De	sign				t.		
Col	lor	Matte black	Matte black	Orange	Orange	Gray	
Ad	hesive	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic	
Bad	cking	Fabric, copper	Copper	Copper	Copper	Fabric	
	ecial tures	Modern, matte black design	Modern, matte black design with high shielding	Excellent bonding	Low-pressure activation, high conductivity	Low-pressure activation high conductivity	
	20 µm		• 60332				
	25 µm	• 60231					
	30 µm		• 60333	• 60537	• 60317	● 60347	
622	35 µm	• 60232					
	40 µm		• 60334				
F	45 µm	• 60238					
	50 µm			• 60538	• 60318	● 60348	
	55 µm	• 60234					
Product performance	Reference product	• 60232	• 60333	• 60537	• 60317	● 60347	
	Peel adhesion [N/cm; SUS initial/ ultimate]	3.5/4.5	4.0	6.3/7.5	4.6/5.3	3.5/4.8	
	Contact resistance [Ω/inch²]	0.05	0.05	0.05	0.03	0.03	
	Surface resistance [Ω/sq]	0.2	0.1	0.2	0.2	0.2	
	Shielding effective- ness [-dB]	>50	>70	>70	>70	>60	

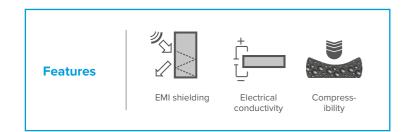
Didn't find what you were looking for?

We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands.

Single-sided electrically conductive foam tapes

For conductive gap filling

Our single-sided electrically conductive foam tapes can be used for shielding, grounding, and filling gaps. They will provide either outstanding conformability and recovery properties or very high abrasion resistance, depending on the foam material chosen. All series in this assortment have very good shock-absorbing and cushioning properties.



Typical applications



FPC grounding

FPC Shielding

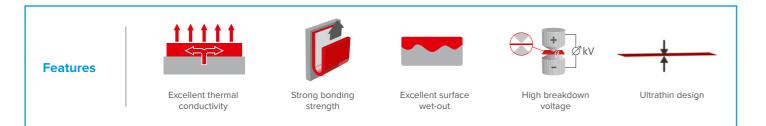


		tesa® 6021x	tesa® 6068x	tesa® 6024x		
Design				ţ.		
Colo	r	Gray	Gray	Gray		
dhe	esive	Conductive acrylic	Conductive acrylic	Conductive acrylic		
ack	ting	Soft foam	Ultrasoft foam	Gasket foam		
Special features		Excellent electrical conductivity	Excellent compressibility	Abrasion resistance		
	200 µm	● 60213				
	300 µm	● 60214		● 60246		
	500 µm	© 60215	• 60685	• 60248		
	700 µm	© 60210	© 60687	● 60249		
	1,000 μm	0 60216	● 60688			
	1,500 μm	6 0217				
	2,000 μm	● 60218				
	Reference product	© 60214	● 60685	● 60248		
	Peel adhesion [N/cm; SUS initial/ ultimate]	4.8/8.3	6.0/8.0	4.8/6.3		
	Contact resistance [Ω/inch²]	0.03	0.03	0.03		
	Surface resistance [Ω/sq]	0.2	0.2	0.2		
	Shielding effective- ness [-dB]	>70	>60	>70		
	Recovery rate after 24h [%]	90	96	96		



Keeping electronic devices cool

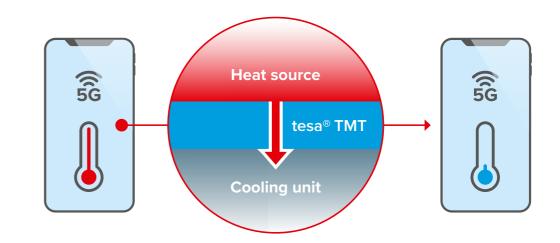
tesa[®] Thermal Management Tapes provides superior thermal transfer performance with excellent bonding properties. It delivers very good surface wet-out on substrates due to the transfer tape design which helps to maximize the thermal transfer efficiency in electronic devices. The available thickness range, which starts from ultrathin 10 μ m and ends at 100 μ m, offers more flexibility in the device design.



Assortment overview

		tesa [®] 6074x				
De	sign					
Co	lor	White				
Ad	hesive	Thermally conductive acrylic				
Sp	ecial features	Excellent thermal transfer efficiency				
	10 µm	O 60742				
ness	30 µm	O 60743				
Thickness	50 µm	O 60744				
-	100 µm	0 60745				
	Reference product	o 60744				
Product performance	Peel adhesion [N/cm; SUS initial/ ultimate]	5.0				
Product p	Thermal conductivity [W/m x K]	1.0				
	Wetting [%]	84				
	Break- down voltage [kV]	2.9				

Cooling scenario



Typical applications

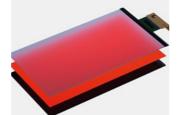


Thermal management

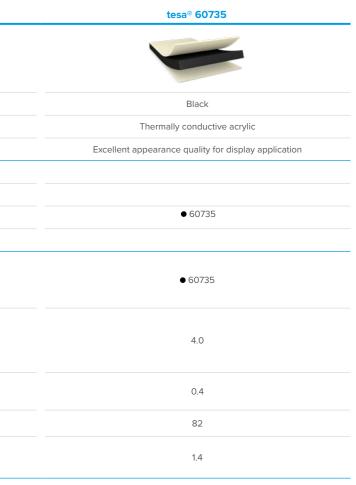




Vapor Chamber mounting



Thermal management for display



Black O White



Optically clear adhesives with special features

Our comprehensive assortment is designed to provide a solution for every display application. All our materials are produced in a clean room and fulfill optically clear requirements, while also being environmentally stable and compatible with other display layers.

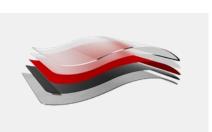
New OCA solutions

In addition to our active assortment, we are constantly developing new adhesive solutions for displays. Our latest innovations include tesa® OCA 693xx for thinner designs and tesa® 71xx with good mura resistance for automotive display. Besides, a range of OCAs that add UV-blocking properties for polarizer less designs are under development.

Typical applications



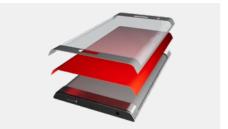
Cover lens lamination



Touch panel lamination



Lamination in VR/AR devices



3D cover lens lamination



Flexible layers

Laminating flexible layers within a foldable or rollable display requires excellent peel adhesion and very good bending properties. For some special substrates like silver nanowire, an OCA tape with good compatibility is required. Contact us to learn more about available solutions.

Assortment overview

	tesa® 693xx	tesa® 699xx	tesa [®] 698xx	tesa [⊚] 696xx	tesa® 71xx	tesa® 58xx	tesa [⊚] 694xx	tesa [®] 692xx	tesa® 6156x	tesa® 6153x
Design										
Color	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Beige
Туре	UV-curable	UV-curable	UV-curable	UV-curable	PSA	PSA	PSA	PSA	PSA	PSA
UV-curing dosage [mj/cm ²]	3,000	1,000	3,000	3,000	-	-	-	-	-	-
Special features	High performance for thin design gaps	Curved design lamination	Outgassing resistant	Excellent gap filling	Mura resistance	Outgassing resistant	Lamination of films	UV-block	Low dK, Iow WVTR	Moisture blocking
15 µm										
25 μm	O 69301	O 69901					O 69401		O 61562	6 1531
50 µm	0 69302	0 69902	0 69802				O 69402		O 61563	● 61533
75 μm									0 61564	
100 μm	0 69304	O 69904	0 69804	O 69604			O 69404	0 69204		
125 μm				O 69605			O 69405			
150 μm		O 69906	O 69806	O 69606	O 7106	O 5806		0 69206		
175 μm				O 69607						
200 μm		O 69908	O 69808	O 69608	O 7108	O 5808		0 69208		
250 μm					O 7110	O 5810				
300 µm			O 69812	O 69612		O 5812				
Reference product	0 69304	O 69904	O 69804	O 69604	O 7108	O 5808	O 69404	O 69204	O 61563**	● 61533**
Glass	11.8	12	10.2	11.1	8.6	9.1	6.9	6.9	5.0	6.5
Peel adhesion [N/cm; ultimate] PET	4.6	10.6	7.6	7.9	7.8	5.7	4.8	4.8	3.3	6.0
PC	14.1	12.6	9.8	10.0	9.4	8.5	7.0	7	4.7	6.8
Transmission [%]	>99	>99	>99	>99	>99	>99	>99	>99	>99	n.a.
Haze [%]	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	n.a.
Refractive index	1.48	1.48	1.48	1.48	1.48	1.47	1.48	1.48	1.52	n.a.
Gap filling [%]	40	15	30	25	20	12	10	5	<10	<10
Dielectric constant ¹	5.7	4.58	4.7	4.5	5.3	6.7	4.9	4.9	2.56	2.92
G' [kPa] ²	348	1,620	250	130	69	124	107	106	550	Upon request
WVTR ³ [g/m ² *day]	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	0.9	0.45
Lag time ⁴ [h]	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	25	10,000

* Further thicknesses might be available upon request.

** Deviating thickness.

1100 kHz

² 25°C, 1 Hz

³ 38°C, 90% rel. humidity, 1 mm

⁴ 60°C, 90% rel. humidity, 6.5 mm gap
⁵ WVTR after all getter is used up

O Transparent O Beige

Global presence



tesa® products prove their impressive quality day in, day out in demanding conditions and are regularly subjected to strict controls. All technical information and data above mentioned are provided to the best of our knowledge on the basis of our practical experience. They shall be considered as average values and are not appropriate for a specification. Therefore tesa SE can make no warranties, express or implied, including, but not limited to any implied warranty of merchantability or fitness for a particular purpose. The user is responsible for determining whether the tesa® product is fit for a particular purpose and suitable for the user's method of application. If you are in any doubt, our technical support staff will be glad to support you.

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Certifications

Our company is focused on international quality, environmental, and occupational safety standards.

Please find more information regarding our certifications at: www.tesa.com/certifications

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tesa.com